

RoHS MLA Varistor Series



Size Table

| Metric | EIA |
|--------|------|
| 1005 | 0402 |
| 1608 | 0603 |
| 2012 | 0805 |
| 3216 | 1206 |
| 3225 | 1210 |

Applications

- Suppression of inductive switching or other transient events such as EFT and surge voltage at the circuit board level
- ESD protection for IEC 61000-4-2, MIL-STD-883c method 3015.7, and other industry specifications (see also the MLE or MLN Series)
- Provides on-board transient voltage protection for ICS and transistors
- Used to help achieve electromagnetic compliance of end products
- Replace larger surface mount TVS Zeners in many applications

Description

The MLA Series (also known as "ML" series) family of transient voltage surge suppression devices is based on the Littelfuse Multilayer fabrication technology. These components are designed to suppress a variety of transient events, including those specified in IEC 61000-4-2 or other standards used for Electromagnetic Compliance (EMC). The MLA Series is typically applied to protect integrated circuits and other components at the circuit board level.

The wide operating voltage and energy range make the MLA Series suitable for numerous applications on power supply, control and signal lines.

The MLA Series is manufactured from semiconducting ceramics, and is supplied in a leadless, surface mount package. The MLA Series is compatible with modern reflow and wave soldering procedures.

It can operate over a wider temperature range than Zener diodes, and has a much smaller footprint than plastic-housed components.

Littelfuse Inc. manufactures other multilayer series products. See the MLE Series data sheet for ESD applications, MHS Series data sheet for high-speed ESD applications, the MLN Series for multilayer protection and the AUML Series for automotive applications.

Features

- RoHS compliant
- Leadless 0402, 0603, 0805, 1206 and 1210 chip sizes
- Multilayer ceramic construction technology
- -55°C to +125°C operating temp. range
- Operating voltage range $V_{MDC} = 5.5V$ to 120V
- Rated for surge current ($8 \times 20\mu s$)
- Rated for energy ($10 \times 1000\mu s$)
- Inherent bi-directional clamping
- Standard low capacitance types available

Absolute Maximum Ratings

For ratings of individual members of a series, see device ratings and specifications table.

| Continuous | ML Series | Units |
|--|-------------|-------|
| Steady State Applied Voltage: | | |
| DC Voltage Range (V_{MDC}) | 3.5 to 120 | V |
| AC Voltage Range ($V_{MIACRMS}$) | 2.5 to 107 | V |
| Transient: | | |
| Non-Repetitive Surge Current, 8/20 μs Waveform, (I_{TM}) | 4 to 500 | A |
| Non-Repetitive Surge Energy, 10/1000 μs Waveform, (W_{TM}) | 0.02 to 2.5 | J |
| Operating Ambient Temperature Range (T_A) | -55 to +125 | °C |
| Storage Temperature Range (T_{STG}) | -55 to +150 | °C |
| Temperature Coefficient (αV) of Clamping Voltage (V_C) at Specified Test Current | <0.01 | %/°C |

Device Ratings and Specifications

| Part Number | Maximum Ratings (125° C) | | | | | Specifications (25° C) | | |
|----------------------------|------------------------------------|--------------------|---|---|---|--|------------------------|---------------------------------|
| | Maximum Continuous Working Voltage | | Maximum Non-repetitive Surge Current (8/20µs) | Maximum Non-repetitive Surge Energy (10/1000µs) | Maximum Clamping Voltage at 1A (or as Noted) (8/20µs) | Nominal Voltage at 1mA DC Test Current | | Typical Capacitance at f = 1MHz |
| | V _{M(DC)} | V _{M(AC)} | I _{TM} | W _{TM} | V _C | V _{N(DC) Min} | V _{N(DC) Max} | C |
| | (V) | (V) | (A) | (J) | (V) | (V) | (V) | (pF) |
| V3.5MLA0603N ⁵ | 3.5 | 2.5 | 30 | 0.100 | 13.0 | 3.7 | 7.0 | 1270 |
| V3.5MLA0805N | 3.5 | 2.5 | 120 | 0.300 | 13.0 | 3.7 | 7.0 | 2530 |
| V3.5MLA0805LN | 3.5 | 2.5 | 40 | 0.100 | 13.0 | 3.7 | 7.0 | 1380 |
| V3.5MLA1206N | 3.5 | 2.5 | 100 | 0.300 | 13.0 | 3.7 | 7.0 | 6000 |
| V5.5MLA0402N | 5.5 | 4.0 | 20 | 0.050 | 21.0 | 7.1 | 10.8 | 220 |
| V5.5MLA0402LN | 5.5 | 4.0 | 20 | 0.050 | 39.0 | 15.9 | 21.5 | 70 |
| V5.5MLA0603N ⁵ | 5.5 | 4.0 | 30 | 0.100 | 17.5 | 7.1 | 9.3 | 500 |
| V5.5MLA0603LN ⁴ | 5.5 | 4.0 | 30 | 0.100 | 17.5 | 7.1 | 9.3 | 450 |
| V5.5MLA0805N | 5.5 | 4.0 | 120 | 0.300 | 17.5 | 7.1 | 9.3 | 1840 |
| V5.5MLA0805LN | 5.5 | 4.0 | 40 | 0.100 | 17.5 | 7.1 | 9.3 | 400 |
| V5.5MLA1206N | 5.5 | 4.0 | 150 | 0.400 | 17.5 | 7.1 | 9.3 | 3500 |
| V9MLA0402N | 9.0 | 6.5 | 20 | 0.050 | 30.0 | 11.0 | 16.0 | 120 |
| V9MLA0402LN | 9.0 | 6.5 | 4 | 0.020 | 35.0 | 11.0 | 16.0 | 33 |
| V9MLA0603N ⁵ | 9.0 | 6.5 | 30 | 0.100 | 25.5 | 11.0 | 16.0 | 490 |
| V9MLA0603LN ⁴ | 9.0 | 6.5 | 30 | 0.100 | 25.5 | 11.0 | 16.0 | 360 |
| V9MLA0805LN | 9.0 | 6.5 | 40 | 0.100 | 25.5 | 11.0 | 16.0 | 520 |
| V12MLA0805LN | 12.0 | 9.0 | 40 | 0.100 | 29.0 | 14.0 | 18.5 | 410 |
| V14MLA0402N | 14.0 | 10.0 | 20 | 0.050 | 39.0 | 15.9 | 21.5 | 70 |
| V14MLA0603N | 14.0 | 10.0 | 30 | 0.100 | 34.5 | 15.9 | 21.5 | 180 |
| V14MLA0805N | 14.0 | 10.0 | 120 | 0.300 | 32.0 | 15.9 | 20.3 | 560 |
| V14MLA0805LN | 14.0 | 10.0 | 40 | 0.100 | 32.0 | 15.9 | 20.3 | 320 |
| V14MLA1206N | 14.0 | 10.0 | 150 | 0.400 | 32.0 | 15.9 | 20.3 | 1400 |
| V18MLA0402N | 18.0 | 14.0 | 20 | 0.050 | 50.0 | 22.0 | 28.0 | 40 |
| V18MLA0603N | 18.0 | 14.0 | 30 | 0.100 | 50.0 | 22.0 | 28.0 | 120 |
| V18MLA0805N | 18.0 | 14.0 | 120 | 0.300 | 44.0 | 22.0 | 28.0 | 520 |
| V18MLA0805LN | 18.0 | 14.0 | 40 | 0.100 | 44.0 | 22.0 | 28.0 | 290 |
| V18MLA1206N | 18.0 | 14.0 | 150 | 0.400 | 44.0 | 22.0 | 28.0 | 1270 |
| V18MLA1210N | 18.0 | 14.0 | 500 | 2.500 | 44.0 at 2.5 | 22.0 | 28.0 | 1440 |
| V26MLA0603N | 26.0 | 20.0 | 30 | 0.100 | 60.0 | 31.0 | 38.0 | 110 |
| V26MLA0805N | 26.0 | 20.0 | 100 | 0.300 | 60.0 | 29.5 | 38.5 | 220 |
| V26MLA0805LN | 26.0 | 20.0 | 40 | 0.100 | 60.0 | 29.5 | 38.5 | 140 |
| V26MLA1206N | 26.0 | 20.0 | 150 | 0.600 | 60.0 | 29.5 | 38.5 | 600 |
| V26MLA1210N | 26.0 | 20.0 | 300 | 1.200 | 60.0 at 2.5 | 29.5 | 38.5 | 1040 |
| V30MLA0603N | 30.0 | 25.0 | 30 | 0.100 | 74.0 | 37.0 | 46.0 | 90 |
| V30MLA0805LN | 30.0 | 25.0 | 30 | 0.100 | 72.0 | 37.0 | 46.0 | 90 |
| V30MLA1210N | 30.0 | 25.0 | 280 | 1.200 | 68.0 at 2.5 | 35.0 | 43.0 | 1820 |
| V30MLA1210LN | 30.0 | 25.0 | 220 | 0.900 | 68.0 at 2.5 | 35.0 | 43.0 | 1760 |
| V33MLA1206N | 33.0 | 26.0 | 180 | 0.800 | 75.0 | 38.0 | 49.0 | 500 |
| V42MLA1206N | 42.0 | 30.0 | 180 | 0.800 | 92.0 | 46.0 | 60.0 | 425 |
| V48MLA1206N | 48.0 | 40.0 | 180 | 0.900 | 100 | 54.5 | 66.5 | 350 |
| V48MLA1210N | 48.0 | 40.0 | 250 | 1.200 | 105.0 at 2.5 | 54.5 | 66.5 | 520 |
| V48MLA1210LN | 48.0 | 40.0 | 220 | 0.900 | 105.0 at 2.5 | 54.5 | 66.5 | 500 |
| V56MLA1206N | 56.0 | 40.0 | 180 | 1.000 | 120.0 | 61.0 | 77.0 | 180 |
| V60MLA1210N | 60.0 | 50.0 | 250 | 1.500 | 130.0 at 2.5 | 67.0 | 83.0 | 440 |
| V68MLA1206N | 68.0 | 50.0 | 180 | 1.000 | 140.0 | 76.0 | 90.0 | 100 |
| V85MLA1210N | 85.0 | 67.0 | 250 | 2.500 | 180.0 at 2.5 | 95.0 | 115.0 | 260 |
| V120MLA1210N | 120.0 | 107.0 | 125 | 2.000 | 260.0 at 2.5 | 135.0 | 165.0 | 80 |

NOTES:

- 1 'L' suffix is a low capacitance and energy version; Contact your Littelfuse sales representative for custom capacitance requirements
- 2 Typical leakage at 25°C < 25µA, maximum leakage 100µA at V_{M(DC)}; for 0402 size, typical leakage < 5µA, maximum leakage < 20µA at V_{M(DC)}
- 3 Average power dissipation of transients for 0402, 0603, 0805, 1206 and 1210 sizes not to exceed 0.03W, 0.05W, 0.1W, 0.1W and 0.15W respectively
- 4 Item is available as 'R' packing option only. All 0402 size items available as 'R' packaging option only. See Packaging section for additional information.
- 5 Item is available in 'H', 'T' and 'A' packing option only. All 0805, 1206 and 1210 parts come as 'H', 'T' and 'A' packing option only. See Packaging section for additional information.

Peak Current and Energy Derating Curve

When transients occur in rapid succession, the average power dissipation is the energy (watt-seconds) per pulse times the number of pulses per second. The power so developed must be within the specifications shown on the Device Ratings and Specifications Table for the specific device. For applications exceeding 125°C ambient temperature, the peak surge current and energy ratings must be derated as shown below.



Figure 1

Peak Pulse Current Test Waveform for Clamping Voltage



Figure 2

O_1 = Virtual Origin of Wave
 T = Time from 10% to 90% of Peak
 T_1 = Rise Time = $1.25 \times T$
 T_2 = Decay Time

Example - For an $8/20 \mu s$ Current Waveform:

$8 \mu s = T_1 = \text{Rise Time}$
 $20 \mu s = T_2 = \text{Decay Time}$

Limit V-I Characteristic for V5.5MLA0402 to V18MLA0402



Figure 3

Limit V-I Characteristic for V9MLA0402L



Figure 4

Limit V-I Characteristic for V3.5MLA0603 to V30MLA0603



Figure 5

Limit V-I Characteristic for V3.5MLA0805L to V30MLA0805L



Figure 6

Limit V-I Characteristic for V3.5MLA0805 to V26MLA0805



Limit V-I Characteristic for V3.5MLA1206 to V68MLA1206



Limit V-I Characteristic for V18MLA1210 to V120MLA1210



Device Characteristics

At low current levels, the V-I curve of the multilayer transient voltage suppressor approaches a linear (ohmic) relationship and shows a temperature dependent effect. At or below the maximum working voltage, the suppressor is in a high resistance modex (approaching $10^6\Omega$ at its maximum rated working voltage). Leakage currents at maximum rated voltage are below $100\mu A$, typically $25\mu A$; for 0402 size below $20\mu A$, typically $5\mu A$.



Figure 10

Speed of Response

The Multilayer Suppressor is a leadless device. Its response time is not limited by the parasitic lead inductances found in other surface mount packages. The response time of the Z_NO dielectric material is less than 1ns and the MLA can clamp very fast dV/dT events such as ESD. Additionally, in "real world" applications, the associated circuit wiring is often the greatest factor effecting speed of response. Therefore, transient suppressor placement within a circuit can be considered important in certain instances.



Figure 12

Clamping Voltage Over Temperature (V_c at 10A)



Figure 11

Energy Absorption/Peak Current Capability

Energy dissipated within the MLA Series is calculated by multiplying the clamping voltage, transient current and transient duration. An important advantage of the multilayer is its interdigitated electrode construction within the mass of dielectric material. This results in excellent current distribution and the peak temperature per energy absorbed is very low. The matrix of semiconducting grains combine to absorb and distribute transient energy (heat) (see Speed of Response). This dramatically reduces peak temperature; thermal stresses and enhances device reliability.

As a measure of the device capability in energy and peak current handling, the V26MLA1206A part was tested with multiple pulses at its peak current rating ($150A$, $8/20\mu s$). At the end of the test, 10,000 pulses later, the device voltage characteristics are still well within specification.



Figure 13

Lead (Pb) Soldering Recommendations

The principal techniques used for the soldering of components in surface mount technology are IR Re-flow and Wave soldering. Typical profiles are shown on the right.

The recommended solder for the MLA suppressor is a 62/36/2 (Sn/Pb/Ag), 60/40 (Sn/Pb) or 63/37 (Sn/Pb). Littelfuse also recommends an RMA solder flux.

Wave soldering is the most strenuous of the processes. To avoid the possibility of generating stresses due to thermal shock, a preheat stage in the soldering process is recommended, and the peak temperature of the solder process should be rigidly controlled.

When using a reflow process, care should be taken to ensure that the MLA chip is not subjected to a thermal gradient steeper than 4 degrees per second; the ideal gradient being 2 degrees per second. During the soldering process, preheating to within 100 degrees of the solder's peak temperature is essential to minimize thermal shock.

Once the soldering process has been completed, it is still necessary to ensure that any further thermal shocks are avoided. One possible cause of thermal shock is hot printed circuit boards being removed from the solder process and subjected to cleaning solvents at room temperature. The boards must be allowed to cool gradually to less than 50° C before cleaning.

Reflow Solder Profile



Wave Solder Profile



Lead-free (Pb-free) Soldering Recommendations

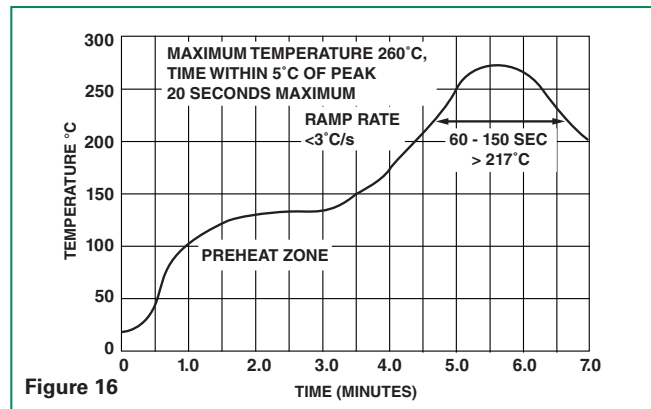
Littelfuse offers the Nickel Barrier Termination option (see "N" suffix in Part Numbering System for ordering) for the optimum Lead-free solder performance, consisting of a Matte Tin outer surface plated on Nickel underlayer, plated on Silver base metal.

The preferred solder is 96.5/3.0/0.5 (SnAgCu) with an RMA flux, but there is a wide selection of pastes and fluxes available with which the Nickel Barrier parts should be compatible.

The reflow profile must be constrained by the maximums in the Lead-free Reflow Profile. For Lead-free wave soldering, the Wave Solder Profile still applies.

Note: the Lead-free paste, flux and profile were used for evaluation purposes by Littelfuse, based upon industry standards and practices. There are multiple choices of all three available, it is advised that the customer explores the optimum combination for their process as processes vary considerably from site to site.

Lead-free Re-flow Solder Profile



Product Dimensions (mm)



NOTE : Avoid metal runs in this area, parts not recommended for use in applications using Silver (Ag) epoxy paste.

| Dimension | 1210 Size | | 1206 Size | | 0805 Size | | 0603 Size | | 0402 Size | |
|-----------------|-------------------|-----------------|-------------------|-----------------|--------------------|------------------|-------------------|----------------|-------------------|-----------------|
| | IN | MM | IN | MM | IN | MM | IN | MM | IN | MM |
| A | 0.160 | 4.06 | 0.160 | 4.06 | 0.120 | 3.05 | 0.100 | 2.54 | 0.067 | 1.70 |
| B | 0.100 | 2.54 | 0.065 | 1.65 | 0.050 | 1.27 | 0.030 | 0.76 | 0.020 | 0.51 |
| C | 0.040 | 1.02 | 0.040 | 1.02 | 0.040 | 1.02 | 0.035 | 0.89 | 0.024 | 0.61 |
| D (max.) | 0.113 | 2.87 | 0.071 | 1.80 | 0.043 | 1.10 | 0.040 | 1.00 | 0.024 | 0.60 |
| E | 0.020 -/+0.010 | 0.50 -/+0.25 | 0.020 -/+0.010 | 0.50 -/+0.25 | 0.020 +/- 0.010 | 0.50 +/- 0.25 | 0.015 -/+0.008 | 0.4 -/+0.20 | 0.010 -/+0.006 | 0.25 -/+0.15 |
| L | 0.125 -/+0.012 | 3.20 -/+0.30 | 0.125 -/+0.012 | 3.20 -/+0.30 | 0.079 -/+0.008 | 2.01 -/+0.20 | 0.063 -/+0.006 | 1.6 -/+0.15 | 0.039 -/+0.004 | 1.00 -/+0.10 |
| W | 0.100 -/+0.012 | 2.54 -/+0.30 | 0.060 -/+0.011 | 1.60 -/+0.28 | 0.049 -/+0.008 | 1.25 -/+0.20 | 0.032 -/+0.060 | 0.8 -/+0.15 | 0.020 -/+0.004 | 0.50 -/+0.10 |

MLA Series

Part Numbering System



*NOTES:

1 V120MLA1210 standard shipping quantities are 1000 pieces per reel for the "H" option and 4000 pieces per reel for "T" option.

2 V3.5 MLA0603, V5.5MLA0603 and V9MLA0603 only available in "H," "T" and "A" packing options.

Packaging*

| Device Size | Quantity | | | |
|-------------|----------------------------|---------------------------|---------------------------|------------------------|
| | 13" Inch Reel ("T" Option) | 7" Inch Reel ("H" Option) | 7" Inch Reel ("R" Option) | Bulk Pack ("A" Option) |
| 1210 | 8,000 | 2,000 | N/A | 2,000 |
| 1206 | 10,000 | 2,500 | N/A | 2,500 |
| 0805 | 10,000 | 2,500 | N/A | 2,500 |
| 0603 | 10,000 | 2,500 | 4,000 | 2,500 |
| 0402 | N/A | N/A | 10,000 | N/A |

*(Packaging) It is recommended that parts be kept in the sealed bag provided and that parts be used as soon as possible when removed from bags.

Tape and Reel Specifications



| Symbol | Description | Dimensions in Millimeters | |
|--------|--|--|-------------------------------|
| | | 0402 Size | 0603, 0805, 1206 & 1210 Sizes |
| A_0 | Width of Cavity | Dependent on Chip Size to Minimize Rotation. | |
| B_0 | Length of Cavity | Dependent on Chip Size to Minimize Rotation. | |
| K_0 | Depth of Cavity | Dependent on Chip Size to Minimize Rotation. | |
| W | Width of Tape | 8 \pm 0.2 | 8 \pm 0.3 |
| F | Distance Between Drive Hole Centers and Cavity Centers | 3.5 \pm 0.05 | 3.5 \pm 0.05 |
| E | Distance Between Drive Hole Centers and Tape Edge | 1.75 \pm 0.1 | 1.75 \pm 0.1 |
| P_1 | Distance Between Cavity Centers | 2 \pm 0.05 | 4 \pm 0.1 |
| P_2 | Axial Drive Distance Between Drive Hole Centers & Cavity Centers | 2 \pm 0.1 | 2 \pm 0.1 |
| P_0 | Axial Drive Distance Between Drive Hole Centers | 4 \pm 0.1 | 4 \pm 0.1 |
| D_0 | Drive Hole Diameter | 1.55 \pm 0.05 | 1.55 \pm 0.05 |
| D_1 | Diameter of Cavity Piercing | N/A | 1.05 \pm 0.05 |
| T_1 | Top Tape Thickness | 0.1 Max | 0.1 Max |

NOTES:

- Conforms to EIA-481-1, Revision A
- Can be supplied to IEC publication 286-3



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.